

Sheet 1 of 1

FORM PTO 1449 (modified)

U.S. DEPARTMENT OF COMMERCE
PATENT AND TRADEMARK OFFICELIST OF REFERENCES CITED BY APPLICANT(S)
(Use several sheets if necessary)

Attorney Docket - P70926US0

Application No. - 10/533,877

Applicant - BASSEZ, et al.

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Examiner [†]	Ref. #	Document No.			Date	Patentee/Applicant
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				□ □		

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Examiner [†]	Ref. #	Author (in CAPITAL LETTERS), Title, Book or Periodical, Volume, Date, Pages
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		Hanafusa, A., et al., "Computer assisted orthosis design system for malformed ears-automatic shape modification method for preventing excessive corrective force," Proceedings of the 22nd Annual Int'l. Conference of the IEEE Engineering in Medicine and Biology Society (CAT. No. 00CH37143), Chic., 2000, vol. 3, pgs. 1976-1978, [XP002277429].
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Examiner Signature

/John Pauls/ (07/29/2010)

Date Considered

07/29/2010

[†]Examiner: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.